

MOSFET

OptiMOS[™]5 Power-Transistor, 60 V

Features

- Ideal for high-frequency switching
 Optimized for chargers
 100% avalanche tested
 Superior thermal resistance

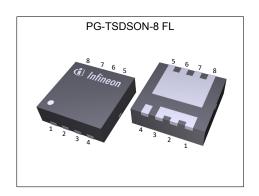
- N-channel, logic level
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
 Qualified for standard grade applications

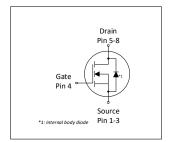
Product validation

Qualified according to JEDEC Standard

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
$V_{ extsf{DS}}$	60	V
$R_{DS(on),max}$	7.3	mΩ
I_{D}	56	A
Qoss	15	nC
Q _G (0V4.5V)	8.7	nC











Type / Ordering Code	Package	Marking	Related Links
ISZ0703NLS	PG-TSDSON-8 FL	0703NL	-

OptiMOS[™]5 Power-Transistor, 60 V



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OptiMOS[™]5 Power-Transistor, 60 V ISZ0703NLS



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	Sumb al	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	56 39 13	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =60 °C/W ²
Pulsed drain current ³⁾	I _{D,pulse}	-	-	224	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	21	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	44 2.5	W	T _C =25 °C T _A =25 °C, R _{THJA} =60 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56

2 Thermal characteristics

Table 3 **Thermal characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
Farameter	Syllibol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	2.5	3.4	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	20	°C/W	-
Device on PCB, 6 cm² cooling area ²⁾	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

OptiMOS[™]5 Power-Transistor, 60 V ISZ0703NLS



Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter.	0		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.1	1.7	2.3	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=15\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	6.4 8.1	7.3 9.2	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =4.5 V, I _D =10 A
Gate resistance ¹⁾	R _G	-	1.2	-	Ω	-
Transconductance	g fs	-	50	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 20 A$

Table 5 **Dynamic characteristics**

Doromotor	Crossball	Values			11	Nata / Tank Canadikian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	1100	1400	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	250	320	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	14	24	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	6.6	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Rise time	t _r	-	1.8	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	13	-	ns	$V_{\rm DD} = 30 \text{ V}, \ V_{\rm GS} = 4.5 \text{ V}, \ I_{\rm D} = 20 \text{ A}, \ R_{\rm G,ext} = 3 \ \Omega$
Fall time	t _f	-	2.5	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Cumbal	Values			l lmi4	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	3.0	-	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	Q _{g(th)}	-	1.7	-	nC	V _{DD} =30 V, I _D =20 A, V _{GS} =0 to 4.5 V
Gate to drain charge	Q _{gd}	-	3.0	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	Q _{sw}	-	4.3	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	8.7	11	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.8	-	V	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	17	23	nC	V _{DD} =30 V, I _D =20 A, V _{GS} =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	15	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge	Qoss	-	15	-	nC	V _{DS} =30 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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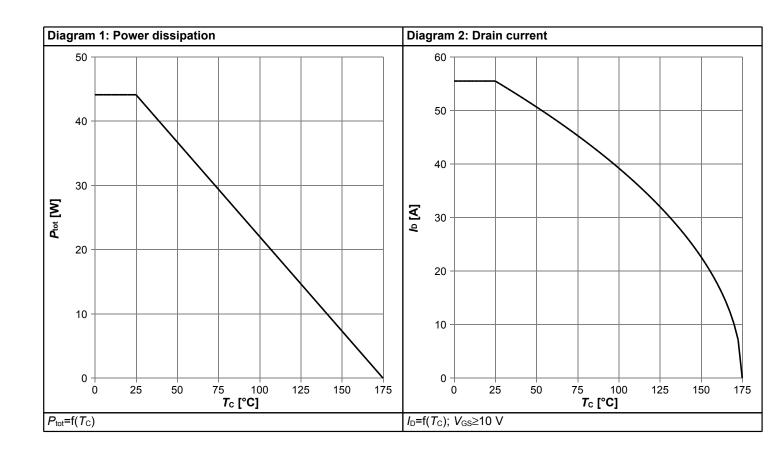


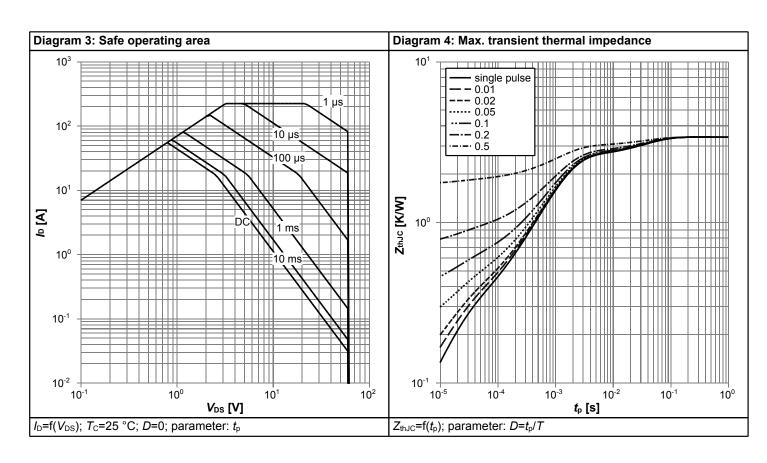
Table 7 Reverse diode

Parameter	Symbol		Values			Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	41	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	224	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.86	1	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	21	-	ns	V _R =30 V, I _F =20 A, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	12	-	nC	V_R =30 V, I_F =20 A, di_F/dt =100 A/ μ s

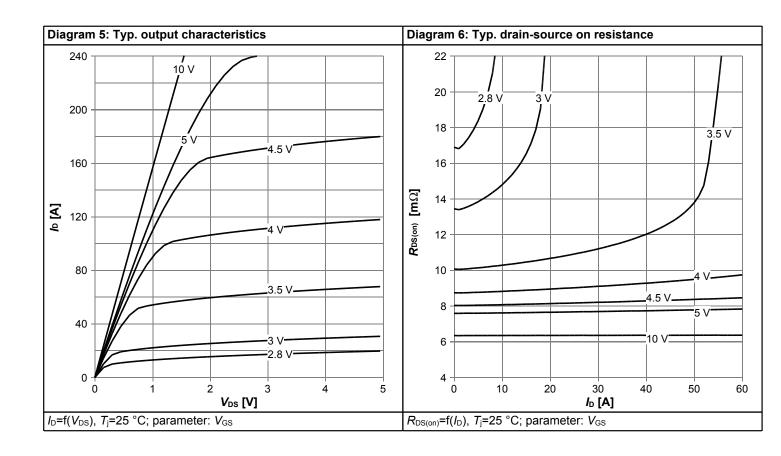


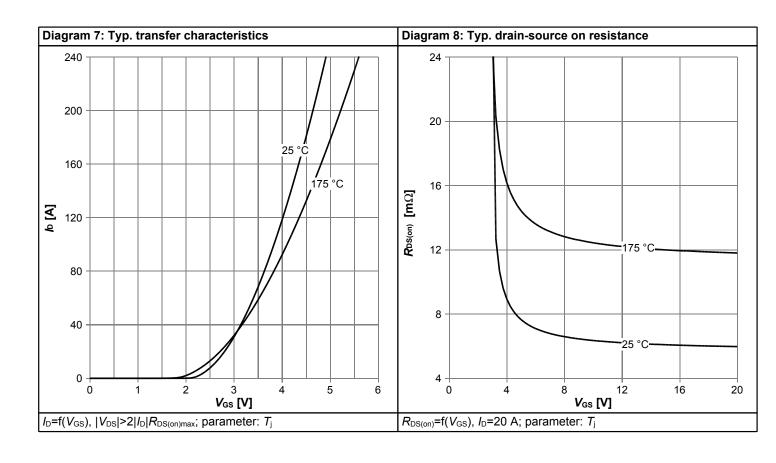
4 Electrical characteristics diagrams



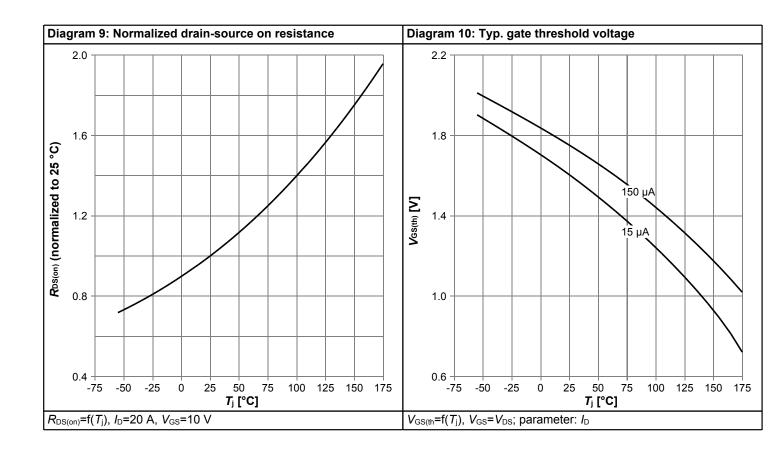


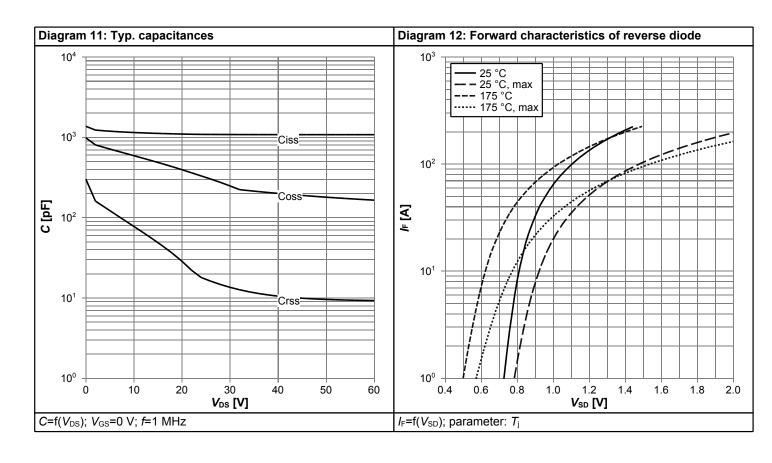




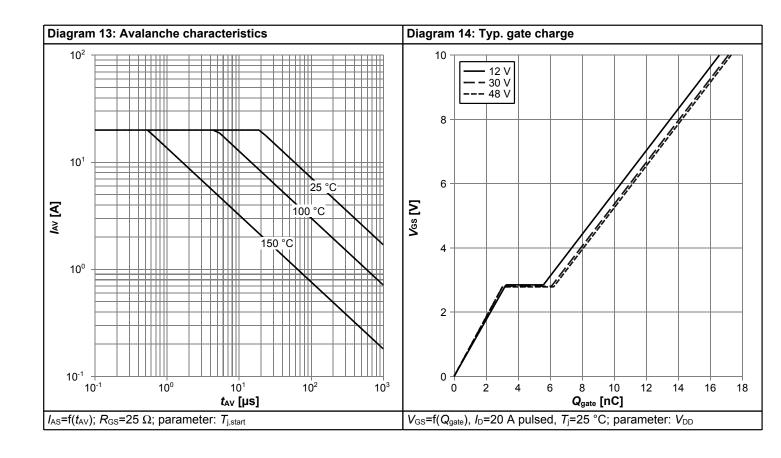


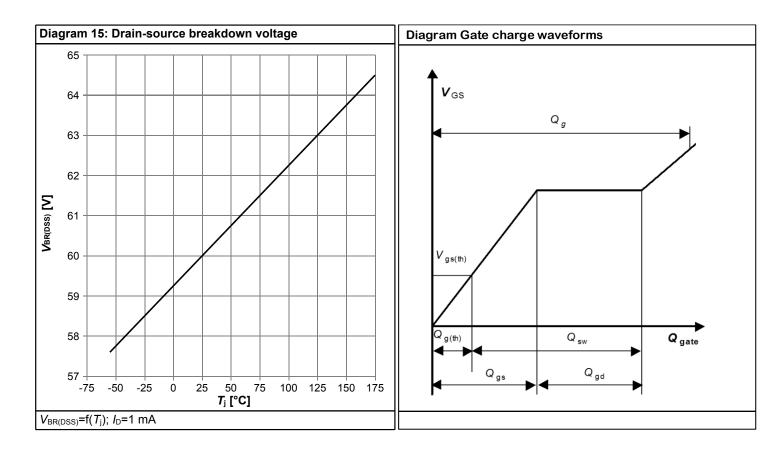






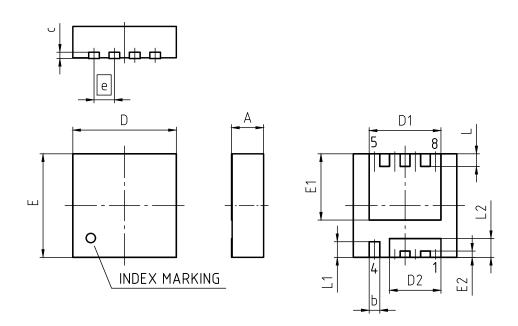








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TSDS	SON-8-U03			
REVISION: 03	DATE:	20.10.2020			
DIMENSIONS	MILLIN	IETERS			
DIMENSIONS	MIN.	MAX.			
Α	0.90	1.10			
b	0.24	0.44			
С	(0	.20)			
D	3.20	3.40			
D1	2.19	2.39			
D2	1.54	1.74			
E	3.20	3.40			
E1	2.01	2.21			
E2	0.10	0.30			
е	0.65				
L	0.30	0.50			
L1	0.40	0.60			
L2	0.50	0.70			
aaa	0.0	06			

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm

OptiMOS[™]5 Power-Transistor, 60 V



Revision History

ISZ0703NLS

Revision: 2021-03-12, Rev. 2.0

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Previous Revision						
Revision Date Subjects (major changes since last revision)						
2.0	2021-03-12	Release of final version				

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